

SKN 240, SKR 240



Stud Diode

V_{RSM} V	V_{RRM} V	$I_{FRMS} = 500$ A (maximum value for continuous operation) $I_{FAV} = 240$ A (sin. 180; $T_c = 122$ °C)	
400	400	SKN 240/04	SKR 240/04
800	800	SKN 240/08	SKR 240/08
1200	1200	SKN 240/12	SKR 240/12
1400	1400	SKN 240/14	SKR 240/14
1600	1600	SKN 240/16	SKR 240/16
1800	1800	SKN 240/18	SKR 240/18

Rectifier Diode

SKN 240
SKR 240

Features

- Reverse voltages up to 1800 V
- Hermetic metal case with glass insulator
- Cooling via heatsinks
- Threaded stud ISO M16 x 1,5, M20 x 1,5²⁾ or ¾ - 16 UNF 2A²⁾
- **SKN**: anode to stud
- **SKR**: cathode to stud

Typical Applications *

- All purpose high power rectifier diodes
- Non-controllable and half-controllable rectifiers
- Free-wheeling diodes
- Recommended snubber network:
 R_C : 0,5 μ F, 30 Ω ($P_R = 2$ W),
 R_p : 50 k Ω ($P_R = 20$ W)

1) Mounting with grease-like thermal compound or joint contact compound
2) M16x1,5 is standard, "UNF" should be added in description for ¾ - 16 UNF thread, while "M20" must be added for M20x1,5
3) To include silicone sleeve, "C/ ESPAG." Should be added in description.

Symbol	Condition	Values	Units
I_{FAV}	sin. 180 ; $T_c = 95$ °C	320	A
I_D	P 1/120; $T_a = 50$ °C; B2 / B6 P 1/120F; $T_a = 40$ °C; B2 / B6	279 / 404 535 / 762	A A
I_{FSM}	$T_{vj} = 25$ °C ; 10 ms $T_{vj} = 180$ °C ; 10 ms	6000 5000	A A
i^2t	$T_{vj} = 25$ °C ; 8,3...10 ms $T_{vj} = 180$ °C ; 8,3...10 ms	180000 125000	A ² s A ² s
V_F	$T_{vj} = 25$ °C, $I_F = 750$ A	max. 1,4	V
$V_{(TO)}$	$T_{vj} = 180$ °C	max. 0,85	V
r_T	$T_{vj} = 180$ °C	max. 0,6	m Ω
I_{RD}	$T_{vj} = 180$ °C ; $V_{RD} = V_{RRM}$	max. 60	mA
Q_{rr}	$T_{vj} = 160$ °C, $-di_F/dt = 10$ A/ μ s	200	μ C
$R_{th(j-c)}$		0,2	K/W
$R_{th(c-s)}$		0,03	K/W
T_{vj}		-40...+180	°C
T_{stg}		-55...+180	°C
V_{isol}		-	V~
M_s	M16 or ¾-16 UNF Stud M20 Stud M16 or ¾-16 UNF Stud (lubricated) ¹⁾ M20 Stud (lubricated) ¹⁾	30 40 22,5 30	Nm Nm Nm Nm
a		5 * 9,81	m/s ²
m	approx.	250	g
Case		E 15	



SKN



SKR

SKN 240, SKR 240

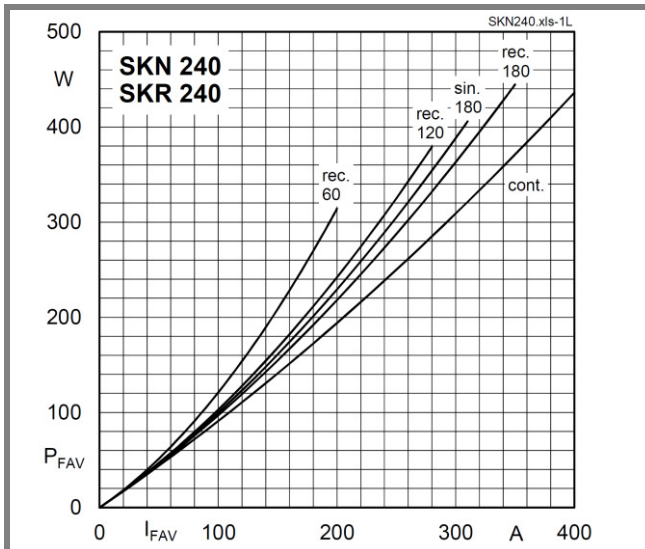


Fig. 1L Power dissipation vs. forward current

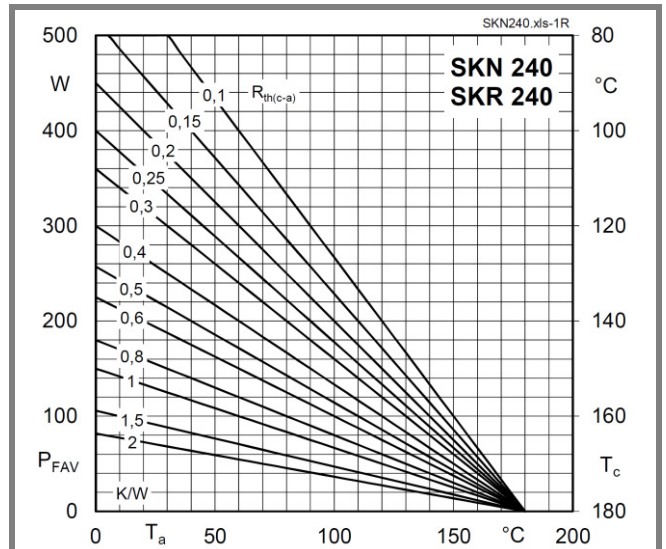


Fig. 1R Power dissipation vs. ambient temperature

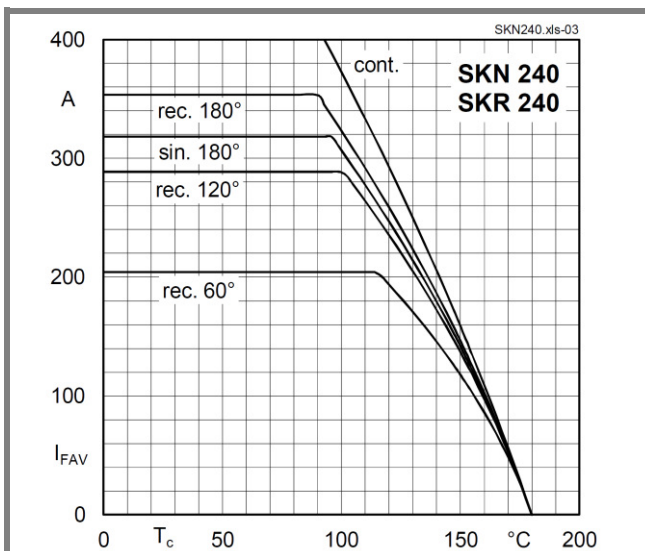


Fig. 3 Forward current vs. case temperature

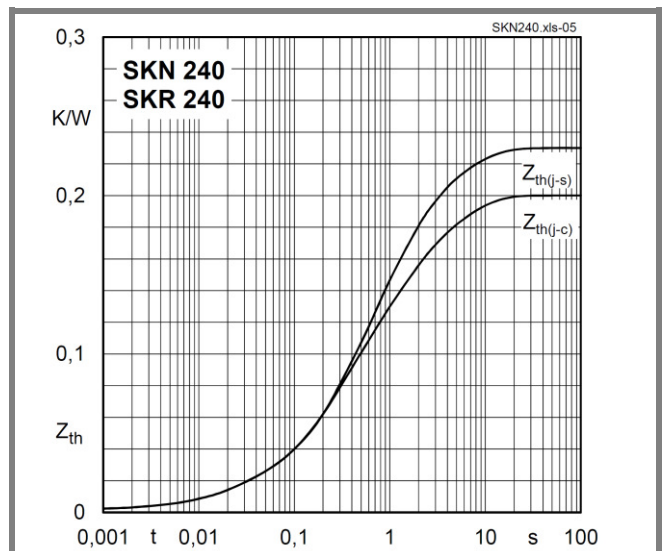


Fig. 5 Transient thermal impedance vs. time

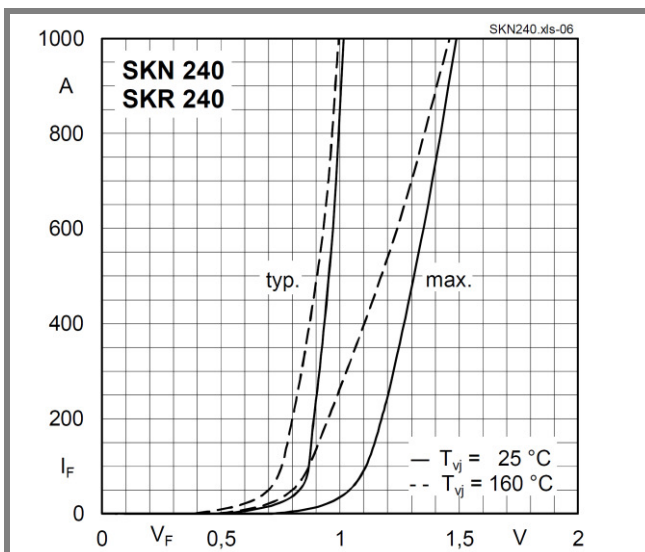


Fig. 6 Forward characteristics

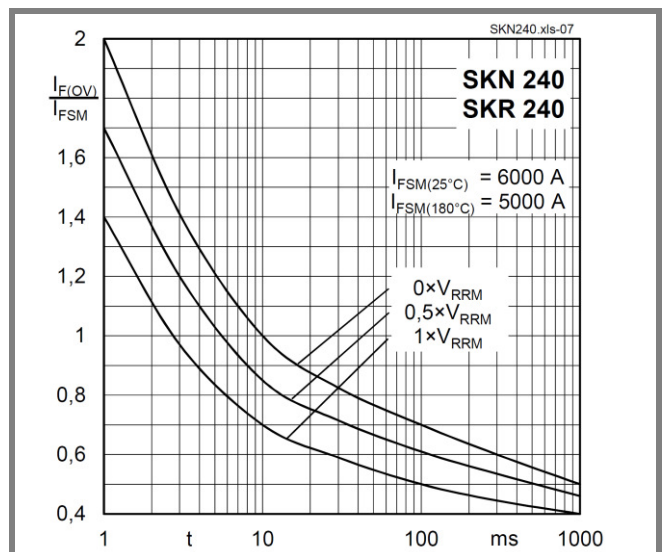
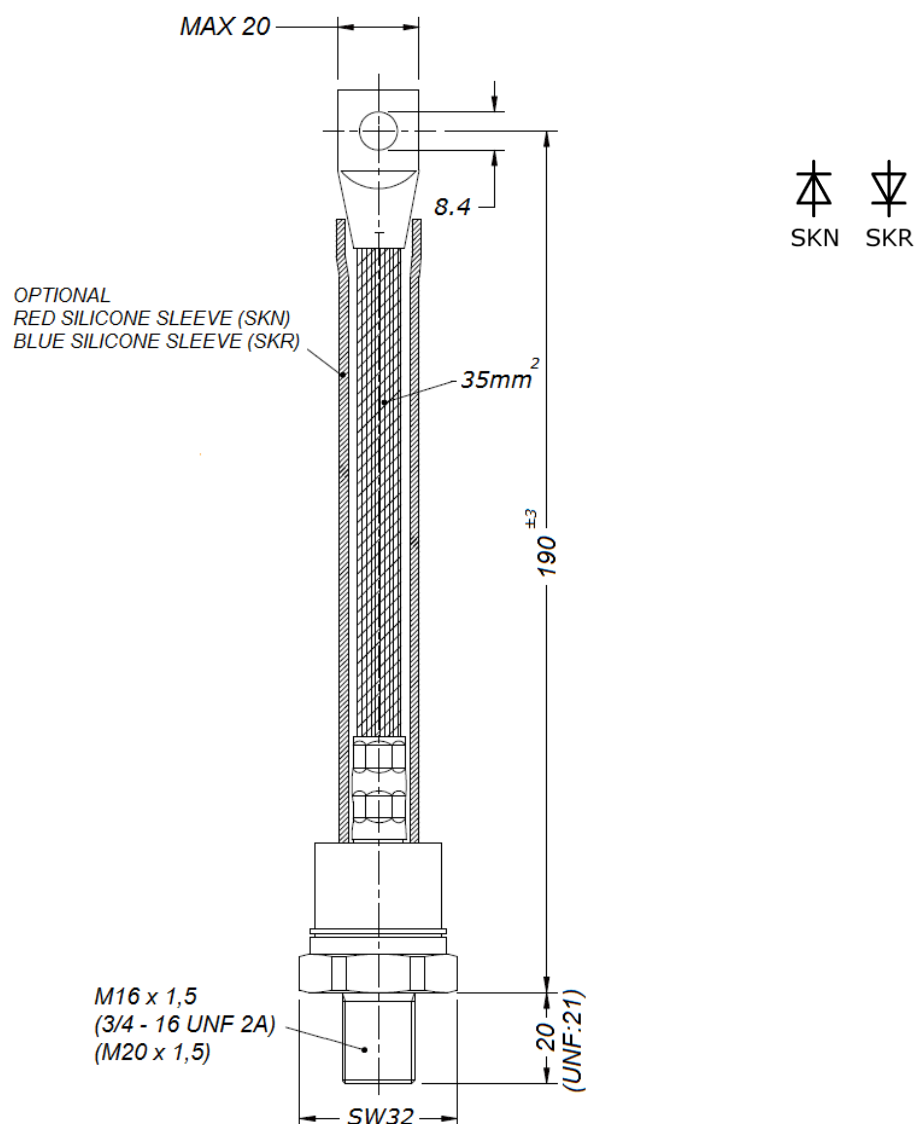


Fig. 7 Surge overload current vs. time

Dimensions in mm



Case E15 (IEC 60191: A 15 M; JEDEC: DO-205 AB)

*IMPORTANT INFORMATION AND WARNINGS

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